


PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.	ADG/16/10025	
1.3 Title of PCI	VND7004AYTR :Datasheet Parameter Optimization	
1.4 Product Category	VND7004AYTR	
1.5 Issue date	2016-12-23	

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Nicola LIPORACE
2.1.2 Marketing Manager	Roberto CRISAFULLI
2.1.3 Quality Manager	Francesco MINERVA

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
General Product & Design	Modification of datasheet	ST MUAR (Malaysia)

4. Description of change

	Old	New
4.1 Description	tskew min:-110, typ:-45, max: 20 µs	tskew min:-65, typ:0, max: 65 µs
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No Impact	

5. Reason / motivation for change

5.1 Motivation	Parametric spec change required for yield optimization as result of volume ramp-up
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change

6.1 Description	New datasheet available on www.st.com In order to assure traceability Finished Good related to this datasheet optimization is VND7004AYTR-FL4
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7. Timing / schedule

7.1 Date of qualification results	2016-12-09
7.2 Intended start of delivery	2017-01-31
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	10025 DocID027772VND7004AY.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2016-12-23

9. Attachments (additional documentations)

10025 Public product.pdf
10025 DocID027772VND7004AY.pdf
10025 5W and Details.pdf

10. Affected parts

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	VND7004AYTR	

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